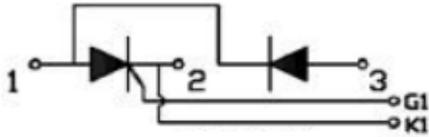


## PRODUCT FEATURES

- Heat transfer through aluminium nitride ceramic isolated metal baseplate
- High Surge Current Capability
- Low Inductance Package

## APPLICATIONS

- DC Motor Control and Drives
- Battery Charges ,Heater controls,Light dimmers
- Temperature control



## ABSOLUTE MAXIMUM RATINGS

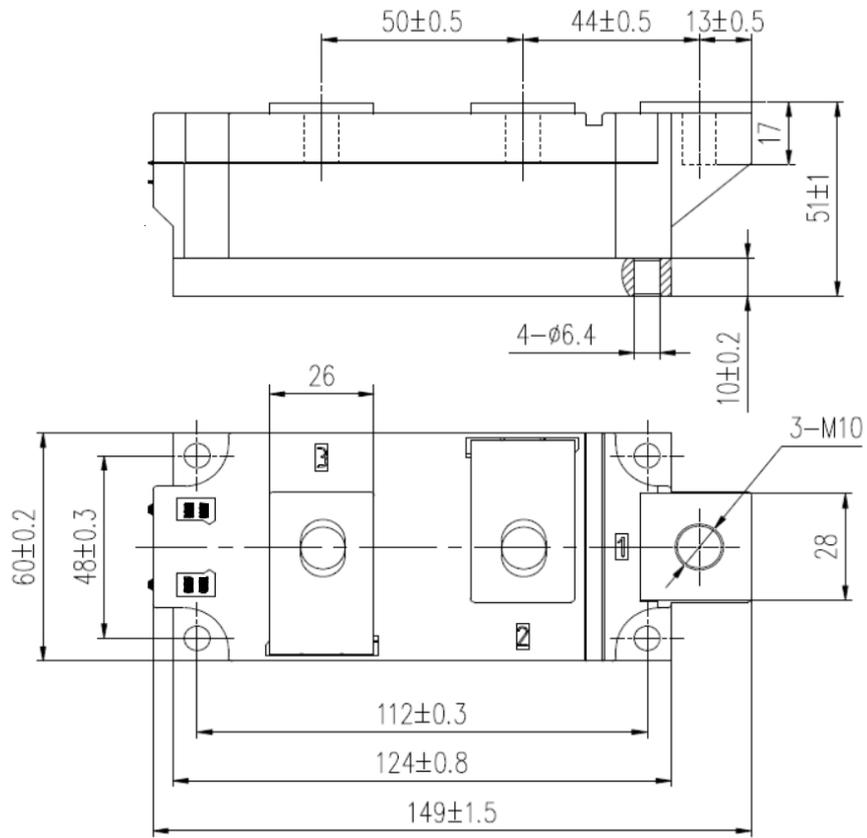
$T_C = 25^\circ\text{C}$  unless otherwise specified

Symbol	Parameter/Test Conditions	Values	Unit
		EK500M90-160UA	
$V_{RRM}$	Repetitive Peak Reverse Voltage	1600	V
$V_{DRM}$	Repetitive Peak Off State Voltage	1600	
$V_{RSM}$	Non-Repetitive Peak Reverse Voltage	1700	

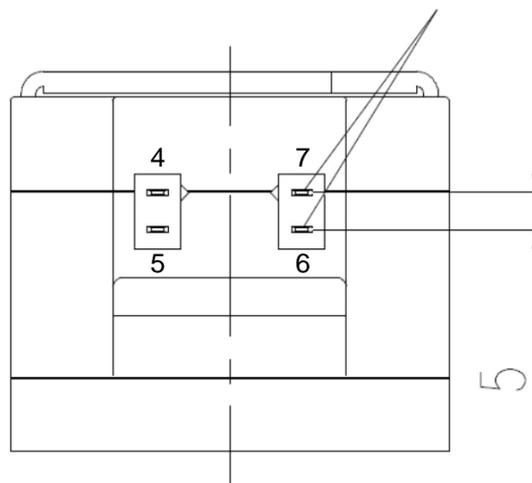
Symbol	Parameter/Test Conditions		Values	Unit
$I_{T(AV)}$	Average On State Current	Single phase, half wave, 180°conduction, $T_c = 85^\circ\text{C}$	500	A
$I_{T(RMS)}$	R.M.S. On State Current	Single phase, half wave, 180°conduction, $T_c = 85^\circ\text{C}$	785	
$I_{TSM}$	Non Repetitive Surge On State Current	$t = 10\text{ms}$ , 50HZ, $T_{jm}$	14500	
$I^2t$	For Fusing	$V_r = 0.6V_{rrm}$ , $T_{jm}$	105.1	$\text{KA}^2\text{S}$
$T_J$	Junction Temperature		-40 to +125	$^\circ\text{C}$
$T_{STG}$	Storage Temperature Range		-40 to +125	$^\circ\text{C}$
$V_{ISO}$	Isolation Breakdown Voltage	AC, 50Hz(R.M.S), $t=1\text{minute}$	3000	V
<b>Torque</b>	Module to Sink	Recommended ( M10 )	11~13	Nm
<b>Torque</b>	Module Electrodes	Recommended ( M6 )	4~6	Nm
$R_{thJC}$	Junction to Case Thermal Resistance		0.070	$\text{K/W}$
<b>Weight</b>			1500	g

**ELECTRICAL CHARACTERISTICS***T<sub>C</sub>=25°C unless otherwise specified*

<b>Symbol</b>	<b>Parameter/Test Conditions</b>	<b>Min.</b>	<b>Typ.</b>	<b>Max.</b>	<b>Unit</b>
<b>I<sub>DRM</sub></b>	Maximum Peak Off-State Current			35	mA
<b>I<sub>RRM</sub></b>	Maximum Peak Reverse Current			35	
<b>V<sub>TM</sub></b>	Maximum on-state voltage drop			1.8	V
<b>V<sub>GT</sub></b>	Max. required DC gate voltage to trigger	3.0			V
<b>I<sub>GT</sub></b>	Max. required DC gate current to trigger	200			mA
<b>V<sub>GD</sub></b>	Max. required DC gate voltage not to trigger,			0.25	V
<b>I<sub>GD</sub></b>	Max. required DC gate current not to trigger,			10	
<b>I<sub>H</sub></b>	Maximum holding current		200		mA
<b>I<sub>L</sub></b>	Maximum latching current		400		mA
<b>P<sub>GM</sub></b>	Maximum peak gate power			15	W
<b>P<sub>G(AV)</sub></b>	Maximum average gate power			5	
<b>dv/dt</b>	Critical Rate of Rise of Off-State Voltage, T <sub>J</sub> =125°C, exponential to 67% rated V <sub>DRM</sub>			800	V/μs
<b>di/dt</b>	V <sub>D</sub> = 2/3V <sub>DRM</sub> , I <sub>G</sub> = 0.3A, dig/dt=0.3A/μs, T <sub>J</sub> = 125°C			150	A/μs



2.8×0.8



**Dimensions in (mm)**  
**Package Outline**